

## **General Description**

The MAX4744/MAX4744H/MAX4745/MAX4745H dual SPDT (single pole/double throw) audio switches feature negative signal capability that allows signals as low as VCC - 5.5V to pass through without distortion. These analog switches have a low on-resistance, low supply current, and operate from a single +1.8V to +5.5V supply.

The MAX4744/MAX4744H have internal shunt resistors that automatically discharge the capacitance at the normally open (NO) and normally closed (NC) terminals when they are not connected. This reduces click-and-pop sounds that occur when switching audio signals between pre-charged points. A break-before-make feature further reduces popping. The MAX4744/MAX4745 control the switches with two control bits CB1 and CB2. The MAX4744H/MAX4745H have one control bit to switch both switches and an enable input EN to put the switches in a high-impedance mode. The MAX4744H/MAX4745H also have an internal protection network against voltages applied to COM\_ when  $V_{CC} = 0V$ .

These devices are available in a space-saving 10-pin µDFN (2mm x 2mm) package and operate over the -40°C to +85°C extended temperature range.

## **Applications**

Speaker Switching **Power Routing** Cellular Phones MP3 Players

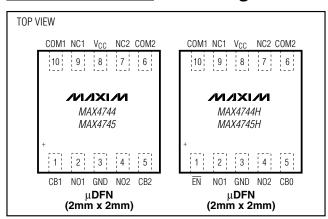
PDAs and other Handheld Devices

**Notebook Computers** 

### **Features**

- ♦ Distortion-Free Negative Signal Throughput Down to Vcc - 5.5V
- ♦ Internal Shunt Resistor Reduces Click/Pop (MAX4744/MAX4744H)
- ♦ 0.6Ω (typ) Low On-Resistance
- ♦ 0.1Ω (max) Channel-to-Channel Matching
- ♦ 0.55Ω (max) On-Resistance Flatness
- ♦ +1.8V to +5.5V Single-Supply Voltage
- ♦ 0.01% (typ) Total Harmonic Distortion
- → -75dB (typ) Crosstalk (100kHz)
- ◆ -68dB (typ) Off-Isolation (100kHz)
- ♦ Available in 10-pin µDFN Package (2mm x 2mm)

## Pin Configurations



## **Ordering Information**

PART	PIN- PACKAGE	TOP MARK	CLICKLESS	COM PROTECTION	PKG CODE
MAX4744ELB+T	10 μDFN-10	+AAF	Yes	No	L1022-1
MAX4744HELB+T	10 μDFN-10	+AAG	Yes	Yes	L1022-1
MAX4745ELB+T	10 μDFN-10	+AAH	No	No	L1022-1
MAX4745HELB+T	10 μDFN-10	+AAI	No	Yes	L1022-1

Note: All devices are specified over the -40°C to +85°C operating temperature range. +Denotes lead-free package.

Maxim Integrated Products 1

### **ABSOLUTE MAXIMUM RATINGS**

(All voltages referenced to GND.)	
V <sub>CC</sub> , CB_, <del>EN</del>	0.3V to +6.0V
NC_, NO	
COM_ (MAX4744/MAX4745)	$(V_{CC} - 6V)$ to $(V_{CC} + 0.3V)$
COM_ (MAX4744H/MAX4745H)	(Note 1)
Continuous Current NO_, NC_, CO	DM±300mA
Peak Current NO_, NC_, COM_ (F	Pulsed at 1ms, 50%
Duty Cycle)	±400mA

Peak Current NO_, NC_, COM_ (Pulsed at 1ms	, 10%
Duty Cycle)	±500mA
ESD Protection per Method 3015.7	
NO_, NC_, COM_, V <sub>CC</sub> , GND, CB_, <del>EN</del>	±2kV
Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )	
10-Pin µDFN (derate 5mW/°C above +70°C)	403mW
Operating Temperature Range	40°C to +85°C
Storage Temperature Range	65°C to +150°C

**Note 1:** If  $V_{CC} > 0.5V$ , limits are  $(V_{CC} - 6V)$  to  $(V_{CC} + 0.3V)$ . If  $V_{CC} < 0.5V$ , limits are  $(V_{CC} - 6.0V)$  to +6.0V.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

 $(V_{CC} = +2.7 \text{V to } +5.5 \text{V}, T_A = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}, \text{ unless otherwise noted.}$  Typical values are at  $V_{CC} = 3.3 \text{V}, T_A = +25 ^{\circ}\text{C}.)$  (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
POWER SUPPLY								
Supply-Voltage Range	Vcc			1.8		5.5	V	
		$V_{CC} = 5.5V$ , $V_{CB} = 0V$ or $V_{C}$	С		0.3	1		
Supply Current	ICC	$V_{CC} = 5.5V$ , $V_{CB} = 0.5V$ or 1	.4V			8	μΑ	
		$V_{CC} = 2.7V$ , $V_{CB} = 0.5V$ or 1	.4V			4		
ANALOG SWITCH								
Analog Signal Range (Note 3)	V <sub>NC_</sub> , V <sub>NO_</sub> , V <sub>COM_</sub> ,			V <sub>CC</sub> - 5.5V		V <sub>C</sub> C	V	
		$V_{CC} = 2.7V$ ; $V_{NC}$ or $V_{NO}$	$T_A = +25$ °C		0.6	0.95		
On-Resistance (Note 4)	Ron	= V <sub>CC</sub> - 5.5V, -1V, 0V, 1V,	$T_A = T_{MIN}$ to $T_{MAX}$			1.0	.0 Ω	
0. 5		$V_{CC} = 2.7V$ , $V_{NC}$ or $V_{NO} = T_A$	T <sub>A</sub> = +25°C			0.1		
On-Resistance Match Between Channels (Notes 4 and 5)	ΔR <sub>ON</sub>		$T_A = T_{MIN}$ to $T_{MAX}$			0.1	Ω	
		V <sub>CC</sub> = 2.7V, V <sub>NC</sub> or V <sub>NO</sub> =	$T_A = +25^{\circ}C$			0.55		
On-Resistance Flatness (Note 6) RFLAT		V <sub>CC</sub> - 5.5V, - 1V, 0V, 1V, 2V, V <sub>CC</sub> ; I <sub>COM</sub> = 100mA	$T_A = T_{MIN}$ to $T_{MAX}$			0.6		
Shunt Switch Resistance	RsH	MAX4744/MAX4744H only, V	CC = 2.7V	2		5	kΩ	
NO NO 0"1 1 0 1		V <sub>CC</sub> = 2.7V switch open;	$T_A = +25$ °C	-15		+15		
NC_, NO_ Off-Leakage Current (Note 3)	INO_(OFF), INC_(OFF)	$V_{NC}$ or $V_{NO}$ = -2.5, +2.5V	$T_A = T_{MIN}$ to $T_{MAX}$	-50		+50	nA	
		$M_{(ON)}$ V <sub>NC</sub> or V <sub>NO</sub> = -2.5, +2.5V; $T_{A} = 0.5$	$T_A = +25$ °C	-15		+15		
COM_ On-Leakage Current (Note 3)	ICOM_(ON)		T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>	-100		+100	nA	

## **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{CC} = +2.7 \text{V to } +5.5 \text{V}, T_A = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}, \text{ unless otherwise noted.}$  Typical values are at  $V_{CC} = 3.3 \text{V}, T_A = +25 ^{\circ}\text{C}.)$  (Note 2)

PARAMETER	SYMBOL	CON	DITIONS		MIN	TYP	MAX	UNITS	
COM_ Leakage Under Protection		V <sub>NC</sub> _ and V <sub>NO</sub> _ are		T <sub>A</sub> = +25°C		30			
Conditions	I <sub>L</sub> (PROT)	unconnected or conf GND; V <sub>CB</sub> = 0V (MAX4744H/MAX474		T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>		500		nA	
DYNAMIC CHARACTERISTICS									
Turn-On Time	ton	$V_{CC} = 2.7V$ , $R_L = 32\Omega$ ,	For NO_, V <sub>CB</sub> _ = 0	$V_{NO} = 1.5V$ , V to $V_{CC}$		55			
Turn on time	TON	$C_L = 35pF$ , Figure 2	For NC_, V <sub>CB</sub> _ = V	V <sub>NC</sub> = 1.5V, C <sub>C</sub> to 0V		560		ns	
Turn-Off Time	torr	$V_{CC} = 2.7V, R_L = 32\Omega, C_L = 35pF,$	For NO_, V <sub>CB</sub> _ = V	V <sub>NO</sub> _ = 1.5V, CC to 0V	540		ne		
Turn-Oil Time	Off Time $ \begin{array}{c c} t_{OFF} & 32\Omega,  C_L = 35 pF, \\ Figure \ 2 & For  NC\_,  V_{NC\_} = 1.5 \\ V_{CB\_} = 0V \ to \ V_{CC} \\ \end{array} $				36		ns		
Break-Before-Make Delay Time	t <sub>D</sub>	$V_{CC}$ = 2.7V, $V_{NC}$ = $V_{NO}$ = 1.5V; for NO_, $V_{CB}$ = $V_{CC}$ to 0V; for NC_, $V_{CB}$ = 0V to $V_{CC}$ ; $R_L$ = 32 $\Omega$ ; $C_L$ = 35pF; Figure 3			20		ns		
Power-Supply Rejection Ratio	PSRR	$f = 100kHz$ , $V_{COM} = 1V_{RMS}$ , $R_L = 50\Omega$ , $C_L = 5pF$			52		dB		
Charge Injection	Q	V <sub>GEN</sub> _ = 0V; R <sub>GEN</sub> =	: 0Ω, C <sub>L</sub> =	1nF, Figure 4		450		рС	
Off-Isolation (Note 7)	V <sub>ISO</sub>	$C_L = 5pF; R_L = 50\Omega;$ $f = 100kHz; V_{COM} = 1V_{RMS}; Figure 5$			-68		dB		
Crosstalk	V <sub>CT</sub>	$C_L = 5pF$ ; $R_L = 50\Omega$ ; $f = 100kHz$ ; $V_{COM} = 1V_{RMS}$ ; Figure 5			-75		dB		
Total Harmonic Distortion	THD	$f = 20$ Hz to 20kHz, $V_{COM} = 0.5$ Vp-p, $R_L = 50\Omega$			0.01		%		
NO_, NC_ Off-Capacitance	C <sub>NO_(OFF)</sub> , C <sub>NC_(OFF)</sub>	f = 1MHz, Figure 6			90		pF		
COM On-Capacitance	CCOM_(ON)	f = 1MHz, Figure 6				300		рF	

## **ELECTRICAL CHARACTERISTICS (continued)**

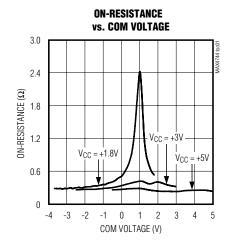
 $(V_{CC} = +2.7 \text{V to } +5.5 \text{V}, T_A = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}, \text{ unless otherwise noted.}$  Typical values are at  $V_{CC} = 3.3 \text{V}, T_A = +25 ^{\circ}\text{C}.)$  (Note 2)

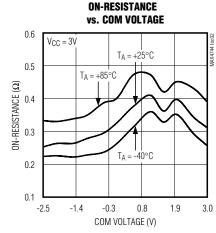
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DIGITAL INPUTS (CB_, EN)						
Input-Logic High	VIH		1.4			V
Input-Logic Low	VIL				0.5	V
Input Leakage Current	ILEAK	V <sub>CB</sub> or V <sub>EN</sub> = 0V or V <sub>CC</sub>	-1		+1	μΑ

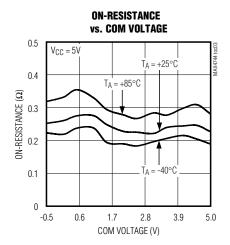
- Note 2: All parameters are production tested at T<sub>A</sub> = +25°C and guaranteed by design over the specified temperature range.
- **Note 3:** Signals on COM\_, NO\_, or NC\_ exceeding V<sub>CC</sub> are clamped by internal diodes. Limit forward-diode current to maximum current ratings.
- Note 4: Guaranteed by design; not production tested.
- **Note 5:**  $\Delta R_{ON} = R_{ON(MAX)} R_{ON(MIN)}$ .
- **Note 6:** Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.
- **Note 7:** Off-isolation =  $20\log_{10}[VC_{OM}/V_{NO}]$ ,  $V_{COM}$  = output,  $V_{NO}$  = input to off switch.

## Typical Operating Characteristics

 $(V_{CC} = +3.3V, T_A = +25^{\circ}C, unless otherwise noted.)$ 

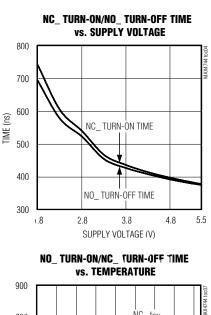


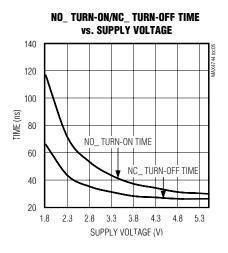


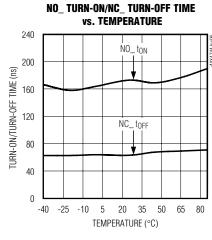


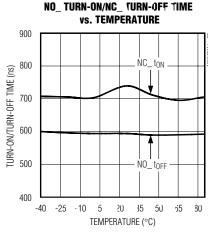
**Typical Operating Characteristics** 

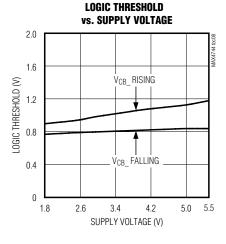
 $(V_{CC} = +3.3V, T_A = +25^{\circ}C, unless otherwise noted.)$ 

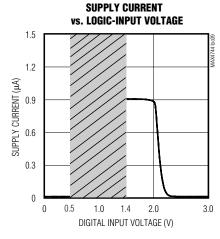


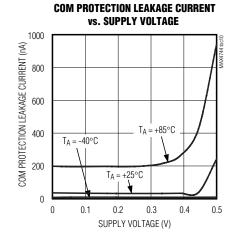


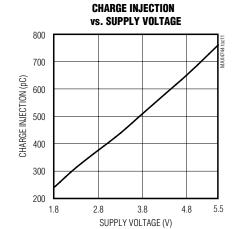






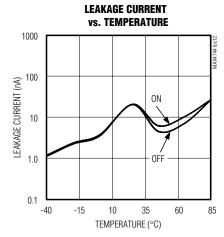


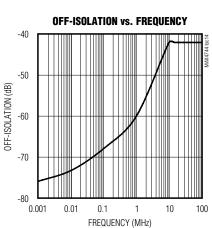


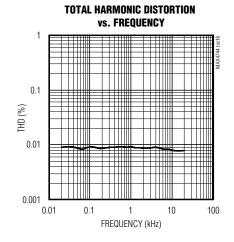


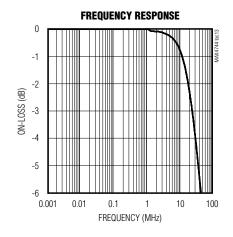
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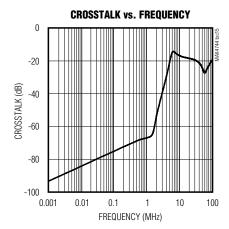
( $V_{CC}$  = +3.3V,  $T_A$  = +25°C, unless otherwise noted.)

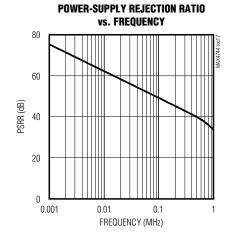












## **Pin Description**

PI	IN			
MAX4744/ MAX4745	MAX4744H/ MAX4745H	NAME	FUNCTION	
1	_	CB1	Digital Control Input for Analog Switch 1	
_	1	ĒN	Enable Input. Driving EN high causes all switches to be high impedance. Pull EN low for normal operation.	
2	2	NO1	Analog Switch 1 – Normally Open Terminal	
3	3	GND	Ground	
4	4	NO2	Analog Switch 2 – Normally Open Terminal	
5	_	CB2	Digital Control Input for Analog Switch 2	
_	5	CB0	Digital Control Input for Analog Switches 1 and 2	
6	6	COM2	Analog Switch 2 – Common Terminal	
7	7	NC2	Analog Switch 2 – Normally Closed Terminal	
8	8	Vcc	Positive Supply Voltage from +1.8V to +5.5V	
9	9	NC1	Analog Switch 1 – Normally Closed Terminal	
10	10	COM1	Analog Switch 1 – Common Terminal	

## Detailed Description

The MAX4744/MAX4744H/MAX4745/MAX4745H are low on-resistance, low-voltage, dual-SPDT analog switches that operate from a +1.8V to +5.5V single supply. These devices feature a negative signal capability that allows signals as low as VCC - 5.5V to pass through without distortion.

The MAX4744/MAX4745 feature two digital control bits to control each switch independently (see Table 1). The MAX4744H/MAX4745H have one control bit to switch both switches and an enable input  $\overline{\text{EN}}$  to put the switches in a high-impedance mode. Driving  $\overline{\text{EN}}$  low takes the switches out of high impedance and CB0 controls both switches (see Table 2).

The MAX4744/MAX4744H have internal shunt resistors on all NO and NC terminals to suppress click-and-pop sounds that can occur when switching audio signals between pre-charged points.

## \_Applications Information

### **Digital Control Inputs**

The MAX4744/MAX4744H/MAX4745/MAX4745H logic inputs accept up to +5.5V, regardless of supply voltage. For example, with a +3.3V supply, CB0, CB1, CB2, and EN can be driven low to GND and high to +5.5V, allowing for mixed logic levels in a system.

### Table 1. MAX4744/MAX4745 Truth Table

CON	TROL	SWITCH STATE		
CB1	CB2	Switch 1	Switch 2	
0	0	Connected to NC1	Connected to NC2	
0	1	Connected to NC1	Connected to NO2	
1	0	Connected to NO1	Connected to NC2	
1	1	Connected to NO1	Connected to NO2	

#### Table 2. MAX4744H/MAX4745H Truth Table

CONTROL		SWITCH STATE		
ĒN	CB0	Switch 1	Switch 2	
0	0	Connected to NC1	Connected to NC2	
0	1	Connected to NO1	Connected to NO2	
1	Х	High Impedance	High Impedance	

X = Don't Care

Driving CB0, CB1, CB2, and  $\overline{\text{EN}}$  rail-to-rail minimizes power consumption.

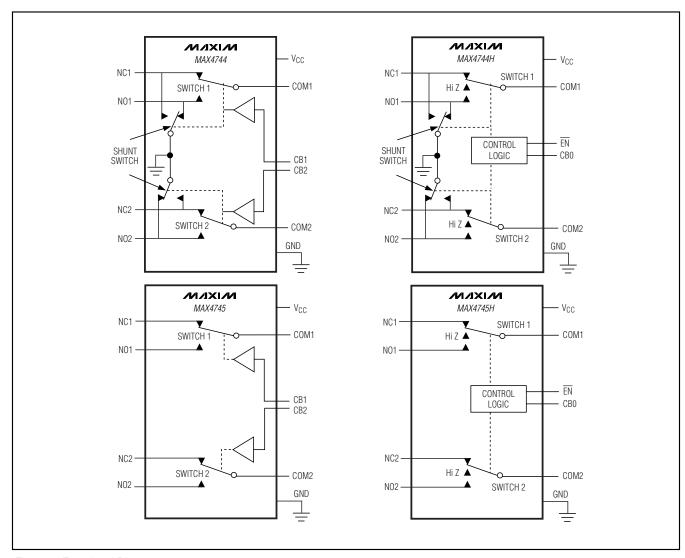


Figure 1. Functional Diagram

#### **Analog Signal Levels**

These devices pass signals from V<sub>CC</sub> to as low as V<sub>CC</sub> - 5.5V, including signals below ground with minimal distortion and very little change in on-resistance (see the *Typical Operating Characteristics*). The switches are bidirectional, so the NO\_, NC\_, and COM\_ terminals can be used as either inputs or outputs.

### COM\_ Protection with Vcc = 0V (MAX4744H/MAX4745H)

This feature prevents any damage to the device due to improper power-supply sequencing. The protection applies if a signal is applied on COM\_ when VCC is less

than 0.5V. The switch is not protected if VCC goes above 0.5V due to parasitic capacitive coupling or any leakage between COM\_ and VCC. The signal at COM\_ ranges between VCC - 6.0V to 6.0V under protection conditions.

### **Click-and-Pop Suppression**

The MAX4744/MAX4744H have a shunt resistor on all their NO and NC terminals to automatically discharge any capacitance when they are not connected to COM. The shunt resistor reduces audible click-and-pop sounds that occur when switching between audio sources. Audible clicks and pops are caused when a

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## Test Circuits/Timing Diagrams

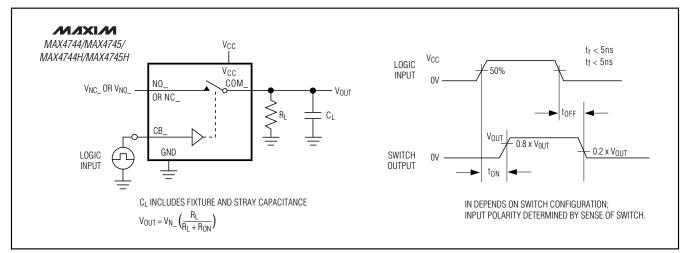


Figure 2. Switching Time

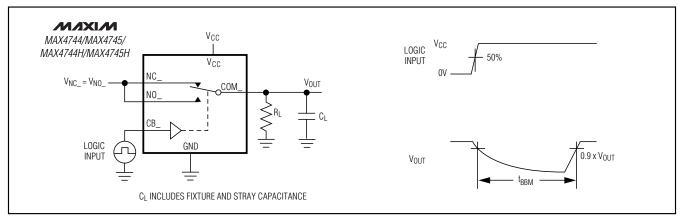


Figure 3. Break-Before-Make Interval

step DC voltage is switched into the speaker. The DC step transients can be reduced by automatically discharging the side that is not connected to the COM terminal, reducing any residual DC voltage and reducing clicks and pops.

### **Break-Before-Make Switching**

All devices feature break-before-make switching which is configured to break (open) the first set of contacts before engaging (closing) the new contacts. This prevents the momentary connection of the old and new signal paths to the output, reducing click-and-pop sounds.

### Power-Supply Sequencing and Overvoltage Protection

Caution: Do not exceed the Absolute Maximum Ratings since stresses beyond the listed ratings may cause permanent damage to the device.

Proper power-supply sequencing is recommended for all CMOS devices. Improper supply sequencing can force the switch into latch-up causing it to draw excessive supply current. The only way out of latch-up is to recycle the power and reapply properly. Connect all ground pins first, then apply power to V<sub>CC</sub>, and finally apply signals to NO\_, NC\_, and COM\_. Follow the reverse order upon power-down.

## **Test Circuits/Timing Diagrams**

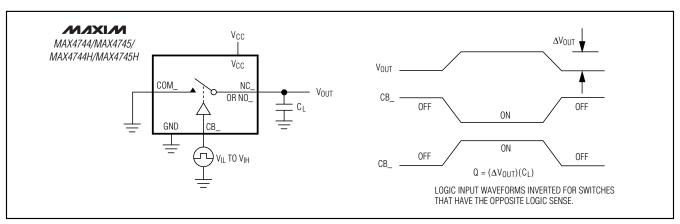


Figure 4. Charge Injection

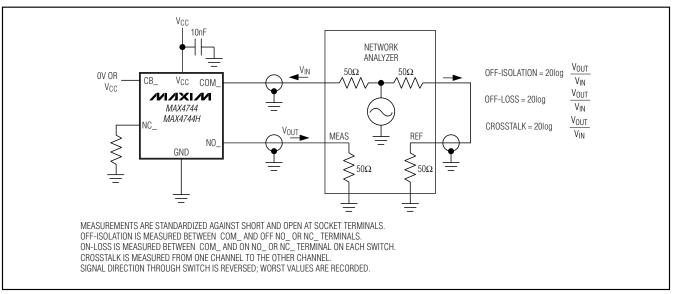


Figure 5. Off-Isolation, On-Loss, and Crosstalk

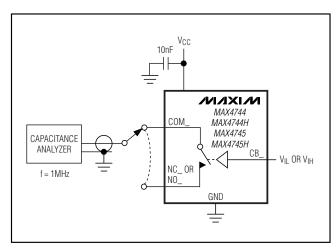
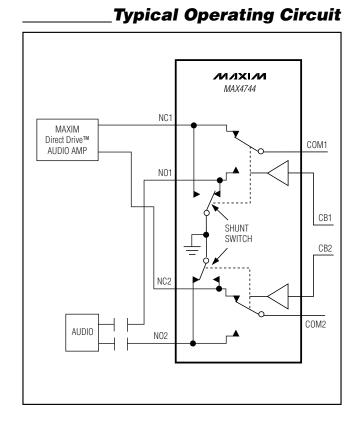


Figure 6. Channel Off-/On-Capacitance

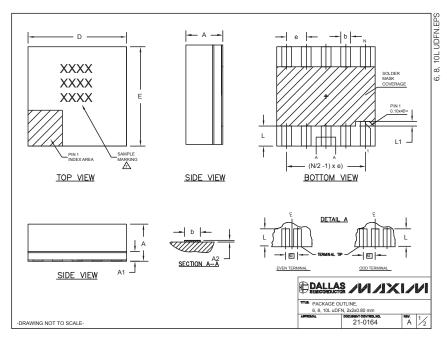
Chip Information

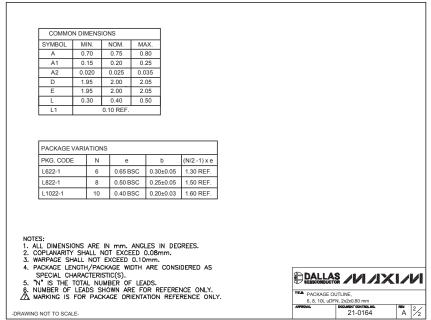
PROCESS: BiCMOS



## **Package Information**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)





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